

TOSHIBA LED LAMP GaP GREEN LIGHT EMISSION

TLGD 262

PANEL CIRCUIT INDICATOR

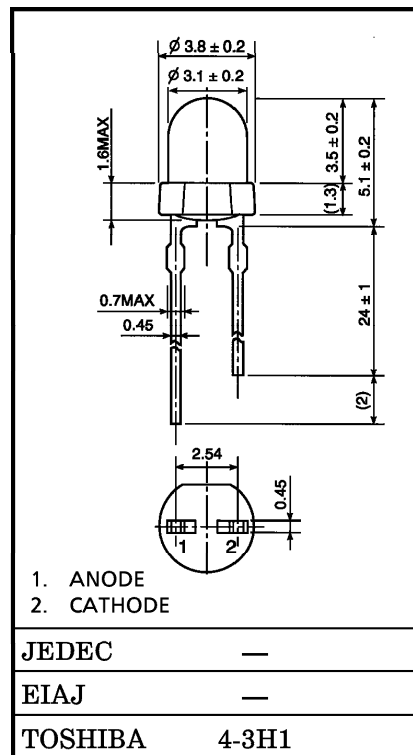
- $\phi 3.1\text{mm}$
- Colorless Transparent Lens
- Low Drive Current, High Intensity Green Light Emission
Recommended Forward Current : $I_F = 10 \sim 15\text{mA}$ (DC)
- All Plastic Molded Lens, Provides an Excellent ON-OFF Contrast Ratio
- Fast Response Time, Capable of Pulse Operation.
- Capable of CMOS Driving
- Wide Radiation Pattern : Suitable for Backlighting
- Application : OA / AV Equipment

Automotive Use

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Forward Current (DC)	I_F	40	mA
Reverse Voltage	V_R	4	V
Power Dissipation	P_D	120	mW
Operating Temperature Range	T_{opr}	$-30\sim 85$	$^{\circ}\text{C}$
Storage Temperature Range	T_{stg}	$-40\sim 120$	$^{\circ}\text{C}$

Unit in mm



Weight : 0.14g

ELECTRO-OPTICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Forward Voltage	V_F	$I_F = 20\text{mA}$	—	2.15	2.8	V
Reverse Current	I_R	$V_R = 4\text{V}$	—	—	5	μA
Luminous Intensity	TLGD262	$I_F = 20\text{mA}$ (Note)	15.3	50	—	mcd
	TLGD262 (KL)		15.3	—	73.6	
	TLGD262 (LM)		27.2	—	129	
Peak Emission Wave Length	λ_p	$I_F = 20\text{mA}$	—	567	—	nm
Spectral Line Half Width	$\Delta\lambda$	$I_F = 20\text{mA}$	—	25	—	nm

(Note) Rank selection carried out under next standard range respectively, although it needs $\pm 15\%$ additional for guaranteed limits.

K : 18-36mcd L : 32-64mcd M : 56-112mcd

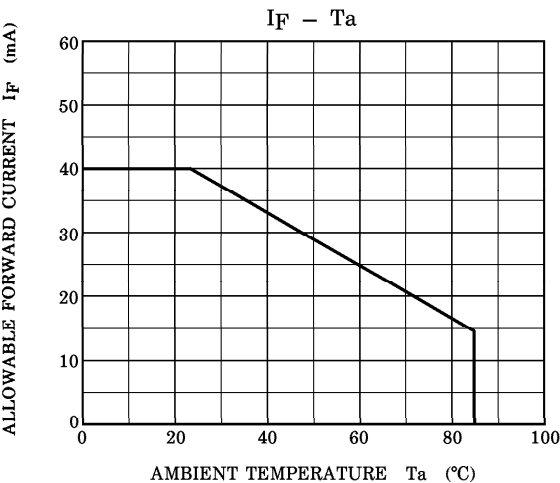
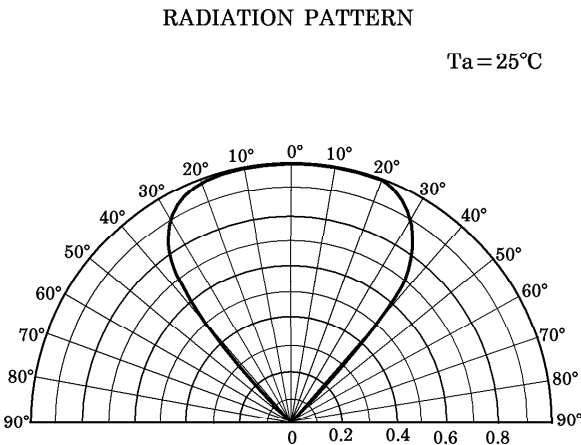
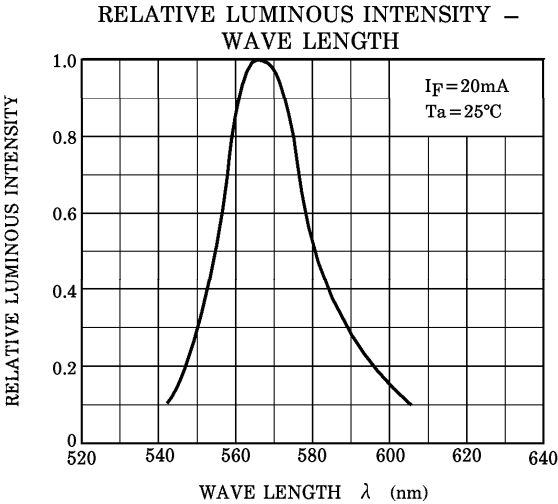
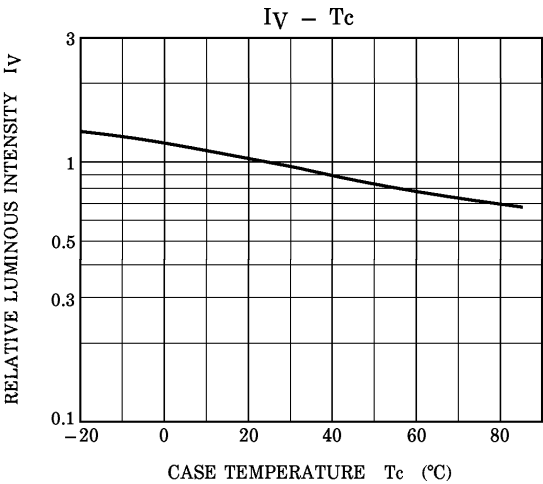
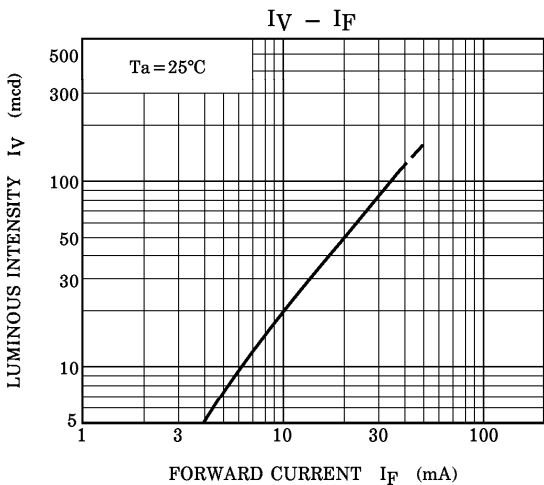
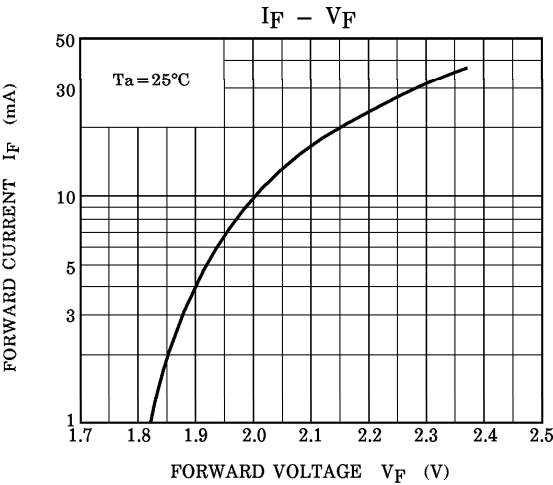
Each rank products is classified by package unit, and (KL) includes K and L.

(LM) includes L and M.

PRECAUTION

Please be careful of the followings.

- Soldering temperature : 260°C MAX. Soldering time : 3s MAX.
(Soldering portion of lead : up to 2mm from the body of the device)
- If the lead is formed, the lead should be formed up to 5mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.



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